

REMARKS

In the Office Action, dated October 20, 2003, the Examiner states that Claims 1-12 are pending, Claims 1-6, 11 and 12 are rejected, and Claims 7-10 are withdrawn. By the present Amendment, Applicant amends the claims.

In the Office Action, Claims 1-2, 4-6, 11 and 12 are rejected under 35 U.S.C. §103(a) as being unpatentable over Spa (US 6,537,359). Claim 3 is rejected in further view of Nagano et al. (US 5,455,117) and Okada et al. (US 6,448,492). The Applicant respectfully disagrees with the above rejections in view of the amendment to Claim 1.

As claimed in amended Claim 1, conductive material is contained in the panel section, and conductivity is developed in the panel section and stimulates the decay of electromagnetic waves. Additionally, the claimed material is formed as a dielectric which causes the reflection of electromagnetic waves due to the dielectric polarization of the incident electromagnetic waves. As a result, the claimed material has a high electromagnetic wave-shielding ability. However, neither Spa nor the other cited references teach the claimed feature that the conductive material is contained in the panel section. Thus, the Applicant considers the rejections to the claims overcome.

In light of the foregoing response, all the outstanding objections and rejections have been overcome. Applicant respectfully submits that this application should now be in better condition for allowance and respectfully requests favorable consideration.

Respectfully submitted,

February 11, 2004
Date


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